



HERSCHEL/SPIRE**HS_DRCU (HS_DCU & HS_FCU) FM
EIDP**

Reference: Sap-SPIRE-QA-421-06
Issue: 1.0
Date: 31/07/06

	Function	Name	Date	Visa
Prepared by	AP Manager	FONTIGNIE Jean	03/08/06	
Approved by	System	CARA Christophe		
Authorized by	Project manager	AUGUERES Jean-Louis	03/07/06	



Herschel /SPIRE

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DSM-DAPNIA SAp

SAP-SPIRE-QA-0421-06

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2 Document status and change record

Date	Issue	Affected pages
31/07/2006	1.0	Creation

3 EIDP Content

Title	Ref	Issue	EIDP Section
Shipping document			1
Minutes of DRB			1
CoC	Sap-SPIRE-QA-424-06	1.0	1
DRCU subsystem specification	Sap-SPIRE-CCa-25-00	1.2	2
DRCU/DPU interface control document	SAP-SPIRE-CCa-0076-02	1.3	2
DRCU interface control document	SAP-SPIRE-CCa-0075-02	1.1	2
HS_DCU MICD	SPIR-MX-5100 000	I	2
HS_FCU MICD	SPIR-MX-5200 000	L	2
HS_RDCU DML	Sap-SPIRE-NC-0060-02	3.0	3
HS_DRCU DPL	Sap-SPIRE-NC-0061-02	3.0	3
HS_DRCU DMPL	Sap-SPIRE-ILM-0382-06	1.0	3
HS_DRCU DCL	Sap-SPIRE-VM-164-04	17	3
HS_DRCU CIDL/ABCL	Sap-SPIRE-QA-417-06	1.0	4
Copies of waivers			4
Copies of major NCR's			4
HS_DRCU User's manual	Sap-SPIRE-CCa-411-06	1.0	5
HS_DRCU packing/ unpacking/ handling procedure	Sap-SPIRE-HT-416-06	1.0	5
HS_DRCU Verification control document	Sap-SPIRE-QA-420-06	1.0	6
HS_DCU fulfilled MICD	Sap-SPIRE-ILM-423-06	--	6
HS_FCU fulfilled MICD	Sap-SPIRE-ILM-422-06	--	6
HS_FCU grounding test report	Sap-SPIRE-CH-412-06	--	6
HS_DCU grounding test report	Sap-SPIRE-CH-408-06	--	6
HS_DCU vibration test report	Sap-SPIRE-HT-393-06	Draft (1.0)	6
HS_FCU vibration test report	Sap-SPIRE-HT-394-06	Draft (1.0)	6
HS_DCU VTC test report	Sap-SPIRE-HT-395-06	Draft (1.0)	6
HS_FCU VTC test report	Sap-SPIRE-HT-396-06	Draft (1.0)	6
HS_DCU performance test report	Sap-SPIRE-CCa-410-06	Draft	6

4 Subsystems EIDP's

This EIDP should come with the following subsystem EIDP's :

Title	Ref	Issue	form
HS_PSU subsystem EIDP	HSPIR.PSU.EID.00209.V.ASTR	0.0	2 ring binders ¹
MCU subsystem EIDP	SE-SPI-MCU-QFM-ADP	0b	2 ring binders

¹ One for PSU, one for harnesses